

### FM320-AL THRU FM3200-AL

## 3.0A Surface Mount Schottky Barrier Rectifiers - 20V-200V

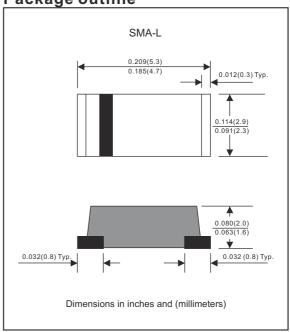
#### **Features**

- Batch process design, excellent power dissipation offers better reverse leakage current and thermal resistance.
- Low profile surface mounted application in order to optimize board space.
- Low power loss, high efficiency.
- High current capability, low forward voltage drop.
- High surge capability.
- Guardring for overvoltage protection.
- Ultra high-speed switching.
- Silicon epitaxial planar chip, metal silicon junction.
- Lead-free parts meet environmental standards of MIL-STD-19500 /228
- Compliant to Halogen-free.
- Suffix "-AU" for Automotive.

#### Mechanical data

- Epoxy:UL94-V0 rated flame retardant
- Case: Molded plastic, DO-214AC/SMA-L
- Terminals : Solder plated, solderable per
  - MIL-STD-750, Method 2026
- Polarity: Indicated by cathode band
- Mounting Position : Any

#### Package outline



#### Maximum ratings and Electrical Characteristics (AT T<sub>A</sub>=25°C unless otherwise noted)

| PARAMETER                  | CONDITIONS                                  | Symbol           | MIN. | TYP. | MAX. | UNIT |
|----------------------------|---|------------------|------|------|------|------|
| Forward rectified current  | See Fig.1                                   | I <sub>o</sub>   |      |      | 3.0  | Α    |
| Forward surge current      | 8.3ms single half sine-wave (JEDEC methode) | I <sub>FSM</sub> |      |      | 80   | Α    |
|                            | $V_R = V_{RRM} T_J = 25^{\circ}C$           |                  |      |      | 0.5  | A    |
| Reverse current            | $V_R = V_{RRM} T_J = 100^{\circ}C$          | I <sub>R</sub>   |      |      | 20   | mA   |
| Thermal resistance         | Junction to ambient                         | R <sub>eJA</sub> |      | 52   |      | °C/W |
| mermarresistance           | Junction to case                            | R <sub>eJC</sub> |      | 26   |      | °C/W |
| Diode junction capacitance | f=1MHz and applied 4V DC reverse voltage    | C <sub>J</sub>   |      | 250  |      | pF   |
| Storage temperature        |   | T <sub>src</sub> | -65  |      | +175 | °C   |

| SYMBOLS   | V <sub>RRM</sub> *1 (V) | V <sub>RMS</sub> *2 (V) | V <sub>R</sub> *3<br>(V) | V <sub>F</sub> *4<br>(V) | Operating temperature T <sub>J</sub> , (°C) |  |
|-----------|-------------------------|-------------------------|--------------------------|--------------------------|---|--|
| FM320-AL  | 20                      | 14                      | 20                       |                          |   |  |
| FM330-AL  | 30                      | 21                      | 30                       | 0.50                     | -55 to +125                                 |  |
| FM340-AL  | 40                      | 28                      | 40                       |                          |   |  |
| FM350-AL  | 50                      | 35                      | 50                       | 0.70                     |   |  |
| FM360-AL  | 60                      | 42                      | 60                       | 0.70                     |   |  |
| FM380-AL  | 80                      | 56                      | 80                       | 0.85                     | FF to 1150                                  |  |
| FM3100-AL | 100                     | 70                      | 100                      | 0.00                     | -55 to +150                                 |  |
| FM3150-AL | 150                     | 105                     | 150                      | 0.90                     |   |  |
| FM3200-AL | 200                     | 140                     | 200                      | 0.92                     |   |  |

- \*1 Repetitive peak reverse voltage
- \*2 RMS voltage
- \*3 Continuous reverse voltage
- \*4 Maximum forward voltage@I<sub>F</sub>=3.0A

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#### Rating and characteristic curves (FM320-AL THRU FM3200-AL)

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

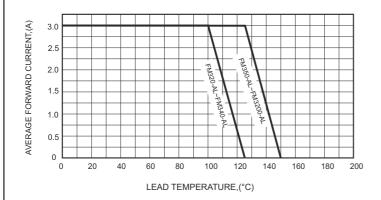


FIG.3-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

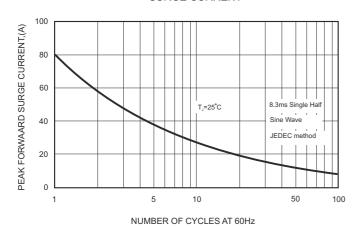


FIG.4-TYPICAL JUNCTION CAPACITANCE

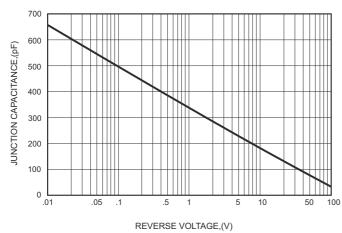


FIG.2-TYPICAL FORWARD

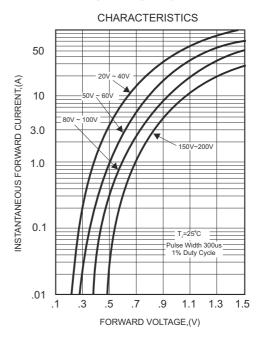
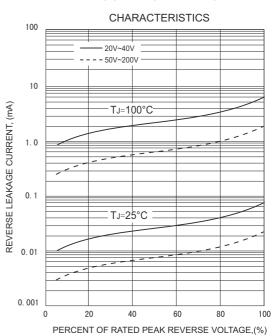


FIG.5 - TYPICAL REVERSE





## FM320-AL THRU FM3200-AL

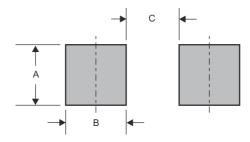
### **Pinning information**

| Pin                        | Simplified outline | Symbol |
|----------------------------|--------------------|--------|
| Pin1 cathode<br>Pin2 anode | 1 2                | 12     |

### Marking

| Type number | Marking code |
|-------------|--------------|
| FM320-AL    | SS32         |
| FM330-AL    | SS33         |
| FM340-AL    | SS34         |
| FM350-AL    | SS35         |
| FM360-AL    | SS36         |
| FM380-AL    | SS38         |
| FM3100-AL   | S310         |
| FM3150-AL   | S315         |
| FM3200-AL   | S320         |
|             |              |

#### Suggested solder pad layout



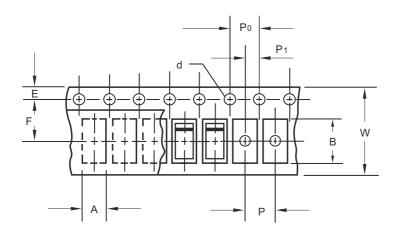
Dimensions in inches and (millimeters)

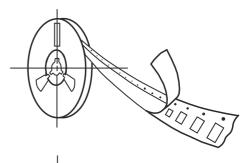
| PACKAGE | А            | В            | С            |
|---------|--------------|--------------|--------------|
| SMA-L   | 0.110 (2.80) | 0.059 (1.50) | 0.110 (2.80) |

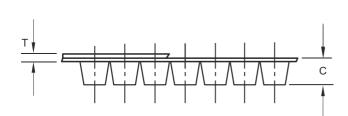
# Formosa MS

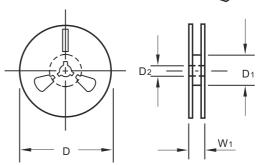
# FM320-AL THRU FM3200-AL

### **Packing information**









unit:mm

| Item                      | Symbol         | Tolerance | SMA-L  |
|---------------------------|----------------|-----------|--------|
| Carrier width             | Α              | 0.1       | 2.90   |
| Carrier length            | В              | 0.1       | 5.50   |
| Carrier depth             | С              | 0.1       | 2.10   |
| Sprocket hole             | d              | 0.1       | 1.50   |
| 13" Reel outside diameter | D              | 2.0       | 330.00 |
| 13" Reel inner diameter   | D1             | min       | 50.00  |
| 7" Reel outside diameter  | D              | 2.0       | 178.00 |
| 7" Reel inner diameter    | D1             | min       | 62.00  |
| Feed hole diameter        | D2             | 0.5       | 13.00  |
| Sprocket hole position    | Е              | 0.1       | 1.75   |
| Punch hole position       | F              | 0.1       | 5.50   |
| Punch hole pitch          | Р              | 0.1       | 4.00   |
| Sprocket hole pitch       | P <sub>0</sub> | 0.1       | 4.00   |
| Embossment center         | P1             | 0.1       | 2.00   |
| Overall tape thickness    | Т              | 0.1       | 0.23   |
| Tape width                | W              | 0.3       | 12.00  |
| Reel width                | W1             | 1.0       | 18.00  |

 $Note: Devices \ are \ packed \ in \ accordance \ with \ EIA \ standar \ RS-481-A \ and \ specifications \ listed \ above.$ 

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# Formosa MS

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#### Reel packing

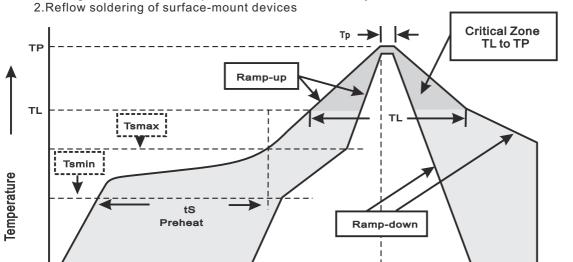
| PACKAGE | REEL SIZE | REEL<br>(pcs) | COMPONENT<br>SPACING<br>(m/m) | BOX<br>(pcs) | INNER<br>BOX<br>(m/m) | REEL<br>DIA,<br>(m/m) | CARTON<br>SIZE<br>(m/m) | CARTON<br>(pcs) | APPROX.<br>GROSS WEIGHT<br>(kg) |
|---------|-----------|---------------|-------------------------------|--------------|-----------------------|-----------------------|-------------------------|-----------------|---------------------------------|
| SMA-L   | 7"        | 2,000         | 4.0                           | 20,000       | 183*155*183           | 178                   | 382*356*392             | 160,000         | 15.5                            |
| SWA-L   | 7"        | 2,000         | 4.0                           | 10,000       | 180*180*80            | 178                   | 440*410*220             | 100,000         | 13.0                            |

#### Suggested thermal profiles for soldering processes

t25°C to Peak

Time

1.Storage environment: Temperature=5°C~40°C Humidity=55%±25%



3.Reflow soldering

| Profile Feature   | Soldering Condition         |
|---|-----------------------------|
| Average ramp-up rate(T∟ to T <sub>P</sub> )                                   | <3°C/sec                    |
| Preheat -Temperature Min(Tsmin) -Temperature Max(Tsmax) -Time(min to max)(ts) | 150°C<br>200°C<br>60~120sec |
| Tsmax to T∟<br>-Ramp-upRate   | <3°C/sec                    |
| Time maintained above: -Temperature(TL) -Time(tL)                             | 217°C<br>60~260sec          |
| Peak Temperature(T♭)  | 255°C-0/+5°C                |
| Time within 5°C of actual Peak<br>Temperature(t <sub>P</sub> )                | 10~30sec                    |
| Ramp-down Rate  | <6°C/sec                    |
| Time 25°C to Peak Temperature   | <6minutes                   |

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